

CHT-NEPTUNE-1210 PRELIMINARY DATASHEET

Version: 4.4 (see note 1)

High Temperature

1200V/10A Silicon Carbide MOSFET

General description

CHT-NEPTUNE-1210 is a High Temperature, High Voltage, Silicon Carbide MOSFET switch. It is available in a metal TO-257 package – the metal case being electrically isolated from the switch terminals. The product is guaranteed for normal operation on the full range -55°C to +225°C (Tj). The device has a breakdown voltage in excess of 1200V and is capable of switching currents up to 10A. The device features a body diode that can be used as freewheeling diode.

This new version D (PLA8543D), replacing obsolete version C (PLA8543C), offers lower On-Resistance with equivalent switching energies.

Benefits

- High Temperature Operation
- Extended lifetime and high reliability
- Low Switching Energy enabling High Frequency Switching
- Pins electrically isolated from the case easing mechanical and thermal integration
- Seamless driving with HADES[®] gate driver solutions

Features

- Specified from -55 to +225°C (Tj)
- V_{DS} Max: 1200V
- I_{DS} Max Continuous Current
 - 10A at T_C≤210°C
 - \circ 8.7A at T_C=215°C
- Typical On-resistance
 - R_{DSon}= 40 mΩ @ 25°C
 - R_{DSon}= 120 mΩ @ 225°C
- Low Switching Energy
 - o Eon= 240µJ
 - o Eoff= 140µJ
- Voltage control: V_{GS}=-4V/20V
- Gate charge: Q_{GS}=22nC
- Low capacitance: C_{OSS}=76 pF
- Package: TO-257
- Thermal Safe Operation Area model

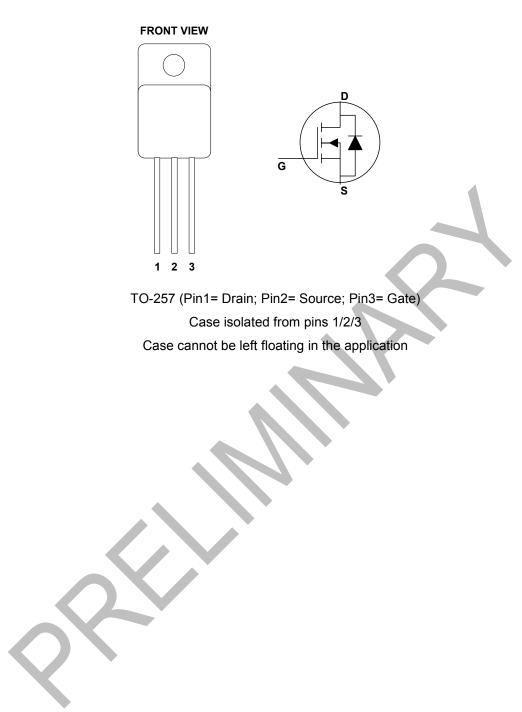
Applications

- High Temperature, High Power Density and Extended Lifetime Power Converters
- DC-AC Converters for motor drives & actuator controls
- DC-DC converters
- AC-DC converters and battery chargers

¹ Please always refer to the latest datasheet version available at http://www.cissoid.com/files/files/products/planet/cht-neptune-1210.pdf



Package Configuration





Absolute Maximum Ratings

Gate-to-Source voltage V_{GS}	-5V to 22V
Drain-to-Source voltage V_{DS} -(0.5V to 1200V
Max DC Drain current I _{DS}	12A
Max pulsed drain current	12A
Max Junction temperature T_{jmax}	α 225°C
Power dissipation (*)	30W

ESD Rating (expected)

>1kV

(*): including switching losses

Human Body Model

Operating Conditions



Electrical characteristics

Unless otherwise stated, T_j =25°C. **Bold** figures point out values valid over the whole temperature range (T_j =-55°C to +225°C).

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Thrashold valtage	V	T _j =25°C ; I _D = 1mA; V _{DS} =20V		4.45		V
Threshold voltage	V _{TH}	T _j =225°C ; I _D = 1mA; V _{DS} =20V		3.28		V
		V _{GS} =0V, V _{DS} =1200V, T _j =25°C		20		nA
Drain cut-off current	I _{DSS}	V _{GS} =0V, V _{DS} =1200V, T _j =225°C		10		μA
		V _{GS} =-5V, V _{DS} =1200V, T _j =225°C		0.5		μA
		V _{GS} =20V, V _{DS} =0V, T _j =25°C		5		nA
Gate leakage current	I _{GSS}	V _{GS} =20V, V _{DS} =0V, T _j =225°C		20		nA
Ctatia duain ta asunas nasistanas	D	V _{GS} =20V, ID=10A, T _j =25°C		40		mΩ
Static drain-to-source resistance	R _{DSon}	V _{GS} =20V, ID=10A, T _i =225°C		120		mΩ
Breakdown drain-to-source volt- age (DC characterization)	V _{BRDS}	V _{GS} =0V; ID = 100 µA	1200			V
Input capacitance	CISS	$V_{GS} = 0V_{DC}, V_{DS} = 600V_{DC}$		1337		pF
Output capacitance	C _{OSS}	f = 1 MHz	- 4	76		pF
Feedback capacitance	C _{RSS}	$V_{AC} = 25 mV$		30		pF
Turn-on delay time	T _{d(ON)}			21		ns
Rise time	Tr			39		ns
Turn-off delay time	T _{d(OFF)}	VDS=600V; VGS= -4/20V; ID = 10A:		49		ns
Fall time	T _f	$RG = 6.8\Omega; L = 856\mu H$	X	24		ns
Turn-On Switching Loss	Eon	110-0.022, E = 000µ11		240		μJ
Turn-Off Switching Loss	E _{off}			140		μJ
Internal gate resistance	R _G	V _{GS} =0V _{DC;} f = 1 MHz; V _{AC} = 25mV		7		Ω
Gate to Source Charge	Q _{GS}			22		nC
Gate to Drain Charge	Q_{GD}	Tj=25°C ;VDS= 600V; ID = 10A; VGS = -4/20V		41		nC
Total Gate Charge	Q_{G}	- ID - IUA, VG34/20V		107		nC

Thermal Characteristics

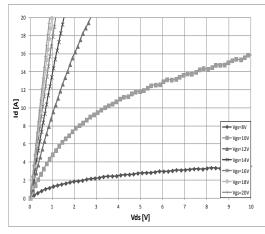
Parameter	Symbol	Condition	Min	Тур	Max	Unit
Junction-to-Case Thermal re- sistance	RO _{JC}			0.95		°C/W

Reverse Diode Characteristics

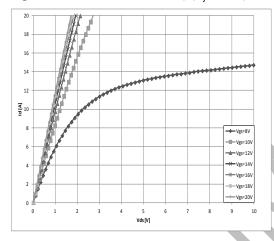
Unless otherwise stated, $T_j = 25^{\circ}$ C. **Bold** figures point out values valid over the whole temperature range ($T_j = -55^{\circ}$ C to +225°C). Timing definitions according to JEDEC 24 page 27

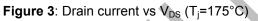
Symbol	Condition	Min	Тур	Max	Unit
Diode forward voltage	Tj=25°C; VGS=-5V; IF=10A		3.6		V
	Tj=25°C; VGS=0V; IF=10A		2.7		V
T _{rr}	Tj=25°C; VDS=600V;		25		ns
Iprr	I _F =20A;dI _F /dt = 1100A/µS		9		А
	V _F T _{rr}	$V_{F} \qquad \begin{array}{c} Tj=25^{\circ}C; VGS=-5V; IF=10A \\ Tj=25^{\circ}C; VGS=0V; IF=10A \\ T_{rr} \qquad Tj=25^{\circ}C; VDS=600V; \\ I \qquad I_{rr} = 20A; dI_{rr}(t) = 1100A (IIS) \end{array}$	$V_{F} \qquad \begin{array}{c} Tj=25^{\circ}C; VGS=-5V; IF=10A \\ Tj=25^{\circ}C; VGS=0V; IF=10A \\ \hline T_{rr} \qquad Tj=25^{\circ}C; VDS=600V; \\ I \qquad I_{rr} = 20A; dI_{rr}(tf=1100A) \\ I \qquad I_{rr} = 20A; dI_{rr}(tf=1100A) \\ \hline I \qquad I_{rr} = 1000A \\ \hline I \qquad I_{rr} = 100A \\ \hline I \ I \ I \ I \ I \ I \ I \ I \ I \ I$	V_F Tj=25°C; VGS=-5V; IF=10A 3.6 Tj=25°C; VGS=0V; IF=10A 2.7 T _{rr} Tj=25°C; VDS=600V; 25 I I=20A:dI=1100A/US 0	V_F Tj=25°C; VGS=-5V; IF=10A 3.6 Tj=25°C; VGS=0V; IF=10A 2.7 T _{rr} Tj=25°C; VDS=600V; 25 I I=25°C; VDS=600V; 25

Typical Performance Characteristics









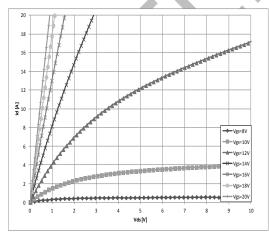


Figure 5: Drain current vs V_{DS} (T_j =-55°C)

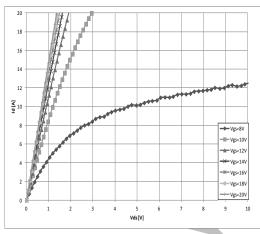


Figure 2: Drain current vs V_{DS} (T_j=125°C)

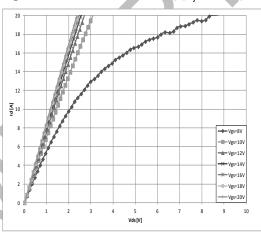


Figure 4: Drain current vs V_{DS} (T_j=225°C)

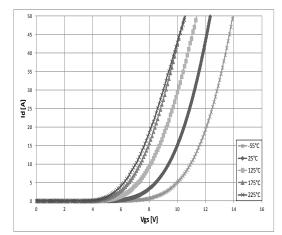
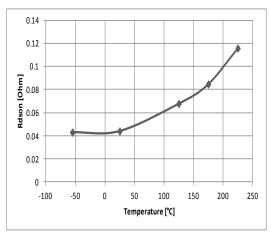
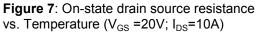
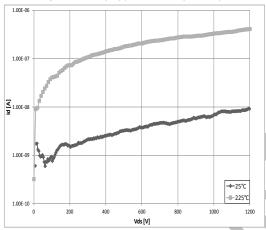


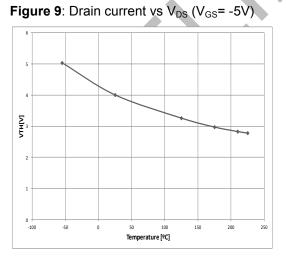
Figure 6: Drain current vs V_{GS} (V_{DS}= 10V)

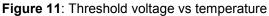
Typical Performance Characteristics (cnt'd)











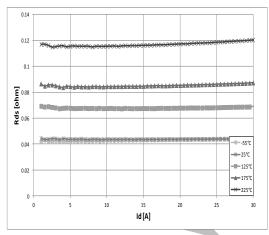


Figure 8: On-state drain source resistance vs. Drain current and temperature (V_{GS} =20V)

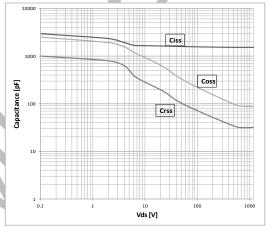
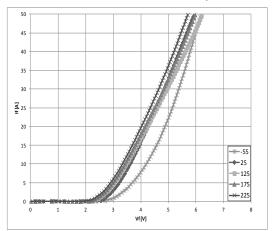
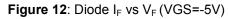
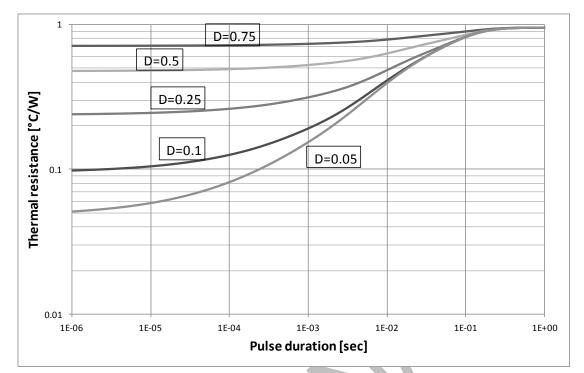


Figure 10:Capacitances vs V_{DS} (T_j=25°C)







Typical Performance Characteristics (cnt'd)



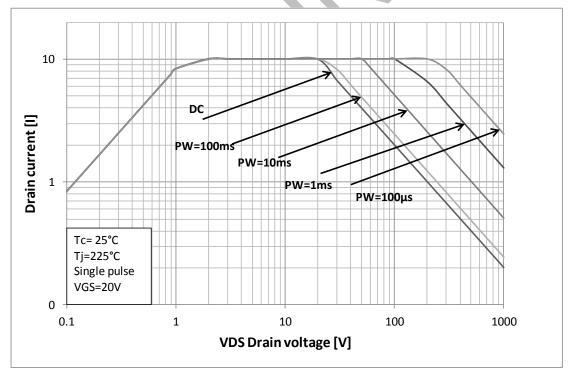


Figure 14: Safe Operating Area



Thermal Safe Operating Area

In power electronics, thermal design is an essential part of the design process. CHT-NEPTUNE-1210 device junction-to-case thermal resistance, R_{thJ-C} is very low (0.95°C/W). However, when designing the system, one needs to take into account the end-to-end junction-to-air thermal resistance which can be evaluated using FEA tools or physical measurements. With too high a thermal resistance, it is possible that any power device will experience thermal runaway. This situation should of course be avoided as it leads to the device destruction.

The graph below will help system designers to dimension their system properly. Firstly, it plots the device resistive losses as a function of temperature for different DC currents. Since Rdson increases with temperature, power dissipation increases with temperature as well. The curves do not include the dissipation due to switching losses which tends to be quite flat over the entire temperature range so therefore an offset may be applied to the curves to take it into account.

Secondly, it plots (in dotted lines) the behavior of the thermal system: the room temperature (point crossing the X-axis at zero power) at which the system operates (e.g. Ta=175°C in the graph example below) and the global junction-to-air thermal resistance (the slope of the straight lines).

To have a stable and healthy system, one needs to ensure that the dotted line (corresponding to the designed thermal system) and the relevant (function of the DC current flowing through the device) power dissipation line are crossing each other at a temperature point below the recommended maximum junction operating point of the device.

As examples:

- With a system thermal resistance of 10°C/W, using CHT-NEPTUNE-1210 with any DC current above 6A will lead a junction temperature outside of the recommended conditions.
- With a system thermal resistance of 2°C/W, the complete specified current range [0A-10A] can be used.

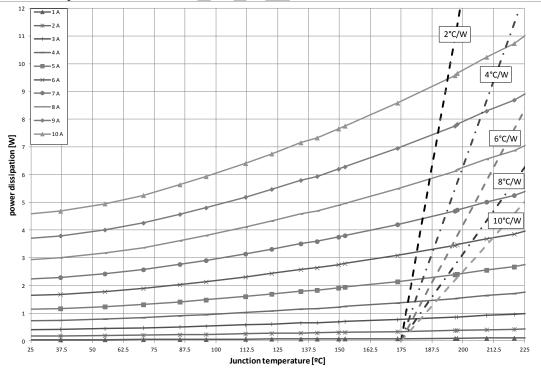
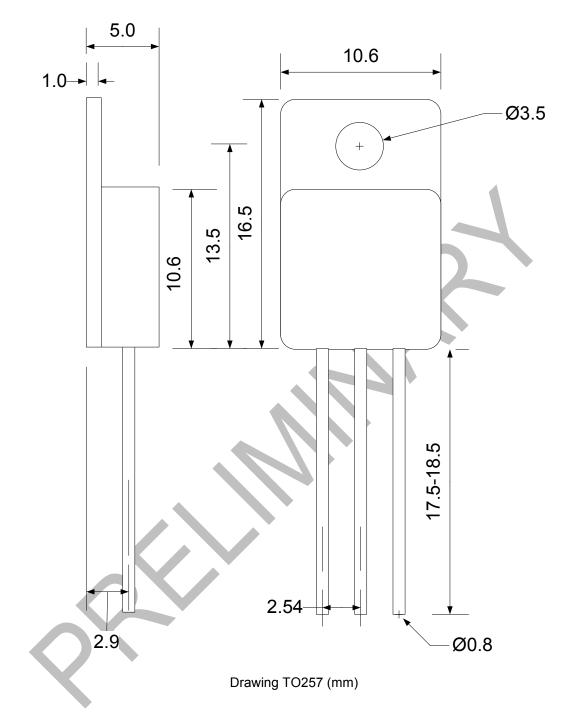


Figure 15: Thermal Safe Operating Area



Package Dimensions





Ordering Information

Product Name	Ordering Reference	Package	Marking
CHT-NEPTUNE-1210	CHT-PLA8543D-TO257-T	TO-257 metal can	CHT-PLA8543D

Contact & Ordering

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